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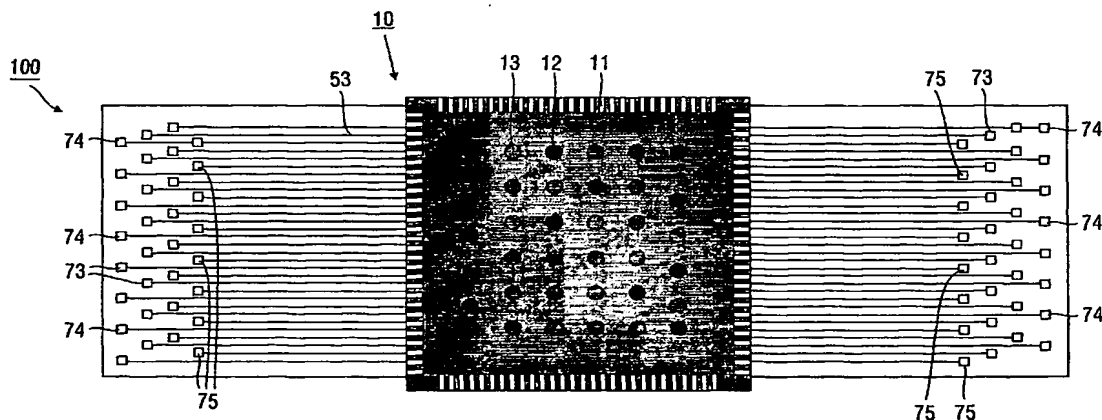
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(54) Title: **ELECTRONIC DEVICE AND CARRIER SUBSTRATE**



(57) Abstract: The electronic device comprises a semiconductor device (10), particularly an integrated circuit, and a carrier substrate (20) with conductive layers on the first side (21) and the second side (22), and voltage supply (62) and ground connections (61) mutually arranged according to a chessboard pattern. These connections (61, 62) extend in a direct path through vertical interconnects and bumps (41, 42) to bond pads at the integrated circuit, which bond pads are arranged in a corresponding chessboard pattern. As a result, an array of direct paths is provided, wherein the voltage supply connections (62) form as much as possible the coaxial center conductors of a coaxial structure.

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